

CRYSTAL OSCILLATOR (SPXO)

OUTPUT: CMOS





Product Number

SG2016CAN: X1G004801xxxx00 SG-210STF: X1G004171xxxx00 SG3225CAN: X1G005961xxxx15 SG5032CAN: X1G004451xxxx00 SG7050CAN: X1G004481xxxx00

SG2016 / 3225 / 5032 / 7050CAN SG-210STF

• Frequency range : 1.2 MHz to 75 MHz (SG2016CAN)

1 MHz to 75 MHz (other than the above)

Supply voltage
 Function
 Operating temperature
 1.8 V to 3.3 V Typ.
 Standby(\$\overline{sT}\$)
 40 °C to +105 °C











SG2016CAN (2.0 x 1.6 mm)

SG-210STF (2.5 x 2.0 mm)

SG3225CAN (3.2 x 2.5 mm)

SG5032CAN (5.0 x 3.2 mm)

SG7050CAN (7.0 x 5.0 mm)

Specifications (characteristics)

Item	Symbol	Specifications				Conditions / Remarks			
Output frequency range	fo	1.2 MHz to 75 MHz			SG2016	CAN	Please contact us about availab		ole
Output frequency range	10	1 MHz to 75 MHz				S	frequencies.		
		1.60 V to 3.63 V			1 MHz ≤ fo ≤ 60 MHz, T_use = +105 °C Max.				
Supply voltage	Vcc	1.71 V to 3.63 V			60 MHz < fo ≤ 75 MHz, T_use = +85 °C Max. Refer to figure *1				
		2.25 V to 3.63 V			60 MHz < fo ≤ 75 MHz, T_use = +105 °C Max.				
Storage temperature	T stg		-55 °C to +125 °C		SG2016	SG2016CAN			
Storage temperature	1_5tg		-40 °C to +125 °C		All others				
Operating temperature	T_use	-20 °C to +70 °C	C, -40 °C to +85 °C, -4	0 °C to +105 °C	See of fi	gure *1			
			$\pm 25 \times 10^{-6}$, $\pm 50 \times 10^{-6}$		-20 °C to	+70 °C			
Frequency tolerance	f_tol	±50 × 10 ⁻⁶				-40 °C to +85 °C			
			±50 × 10 ⁻⁶ , ±100 × 10 ⁻⁶	3	-40 °C to +105 °C				
		V _{CC} = 1.8 V ± 10 %	V _{CC} = 2.5 V ± 10 %	V _{CC} = 3.3 V ± 10 %					
	lcc	1.5 mA Max.	1.6 mA Max.	1.8 mA Max.	No load condition, 1 MHz ≤ fo ≤ 20 MHz				
Current consumption		1.8 mA Max.	2.0 mA Max.	2.2 mA Max.	No load condition, 20 MHz < fo ≤ 40 MHz				
		2.1 mA Max.	2.4 mA Max.	2.6 mA Max.	No load condition, 40 MHz < fo ≤ 60 MHz				
		2.4 mA Max.	2.4 mA Max. 2.8 mA Max. 3.0 mA Max.		No load condition, 60 MHz < fo ≤ 75 MHz				
Stand-by current	I_std	2.1 µA Max. 2.5 µA Max. 2.7 µA Max.			ST =GN	ID			
Symmetry	SYM	45 % to 55 %			50 % Vo	c level, L_CM			
	VoH	90 % V _{CC} Min.			Іон	1.8 V ± 10 % -1 5 mA	2.5 V ± 10 % -3 mA	3.3 V ± 10 % -4 mA	
Output voltage	VoL	10 % Vcc Max.			I _{OL}	15 mA	3 mA	4 mA	
Output voltage	V _{OH-2}	V _{CC} - 0.4 V Min.			Іон	1 8 V±10 % -3 mA	2 5 V±10 % -4 mA	3 3 V±10 % -6 mA	
	V _{OL-2}	0.4 V Max.			I _{OL}	3 mA	4 mA	6 mA	
Output load condition (CMOS)	L_CMOS		15 pF Max.						
Input voltage	V _{IH}	80 % V _{CC} Min.			ST terminal				
input voltage	V _{IL}		20 % V _{CC} Max.		31 terminal				
Rise time and Fall time	tr / tf	3 ns Max. 3.5 ns Max. (@1.8 V±10 %)			20 % V _{CC} to 80 % V _{CC} level, L_CMOS = 15 pF				
Start-up time	t_str	3 ms Max.			T = 0 at 90 % Vcc				
Frequency aging	f_age		$\pm 3 \times 10^{\text{-6}}$ / year Max.		+25 °C, First year				

[Model: SG2016/3225/5032/7050CAN]

Product name SG2016 C AN 25.000000MHz T J G A (\$\sigma\$): Available code DB, JB, JG, JH, LG, LH)

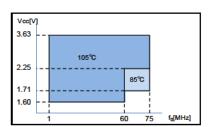
(Standard form) ① ② ③ ④⑤⑥⑦
①Model ②Output(C:CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature range ⑦Internal identification code("A" is default)

T 1.60 to 3.63 V	
K 2.25 to 3.63 V	

⑤Frequency tolerance				
D	±25 × 10 ⁻⁶			
J	±50 × 10 ⁻⁶			
L	±100 × 10 ⁻⁸			

	•	•		
©Operating temperature range				
В	-20 °C to +70 °C			
G	-40 °C to +85 °C			
Н	-40 °C to +105 °C			



*1 : The upper limit of Operating temperature and the related conditions

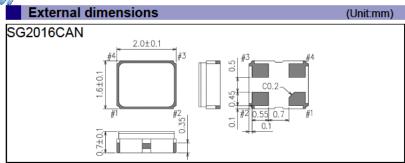
Please note that Supply voltage range (V_{CC}) depends on Output frequency(fo) and upper limit of Operationg temperature(T_use Max.).

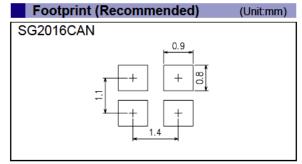
[Model: SG-210STF]

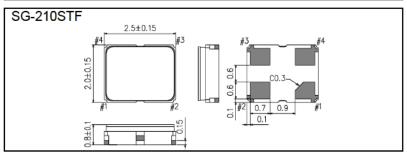
Product name SG-210 S T F 25.0000000MHz L (Standard form) © 23 4 5 (Standard form) (S:Standby) (Supply voltage 4) Frequency (S) Frequency tolerance

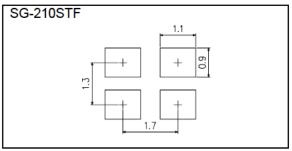
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3 S	upply	vo	Itage		See *1
T	1.6	0 to	3.63	٧	

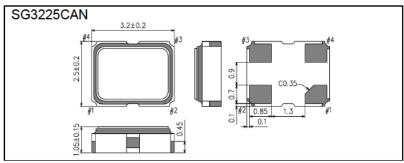
L	⑤Frequency tolerance				
ſ	S	±25 × 10 ⁻⁸ / -20 °C to +70 °C			
	L	±50 × 10 ⁻⁸ / -40 °C to +85 °C			
	Υ	±50 × 10 ⁻⁶ / -40 °C to +105 °C			
	W	±100 × 10 ⁻⁸ / -40 °C to +105 °C			

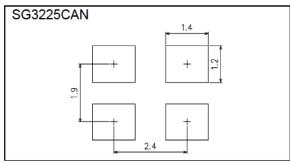


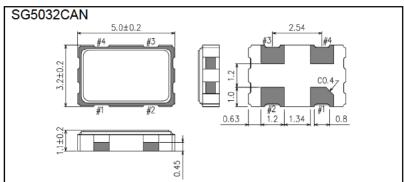


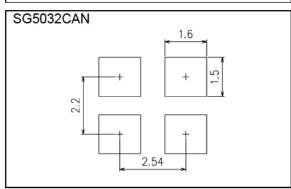


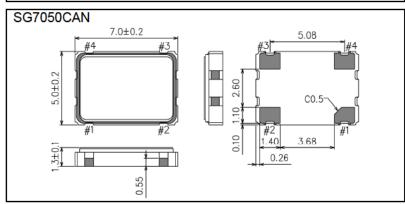


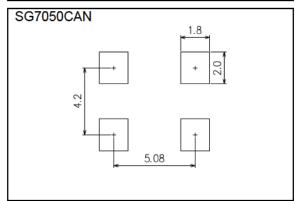












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Pin	Connection	Function							
		ST tem	ST terminal						
4	ST		ST function	Oscillator circuit	Output				
1'	1 31		HIGH or "open"	Oscillation	Specified frequency: Enable				
			LOW	Oscillation stop	High impedance: Disable				
2	GND	Ground	Ground						
3	OUT	Clock o	Clock output						
4	V_{cc}	Power s	Power supply						

■Notes: To maintain stable operation, provide a 0.01uF to 0.1uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

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►Pb free.



► Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



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